## 1. Product profile

### 1.1 General description

The BB182LX is a planar technology variable capacitance diode in a SOD882T ultra small leadless plastic SMD package. The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

### 1.2 Features

- High linearity
- Excellent matching to 2 % DMA
- Ultra small leadless SMD package
- $C_{d(28V)}$ :2.7 pF;  $C_{d(1V)}$  to  $C_{d(28V)}$  ratio: 22
- Low series resistance

### 1.3 Applications

- Voltage Controlled Oscillators (VCO)
- Electronic tuning in VHF television tuners, Band A up to 160 MHz

# 2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	cathode	[1]	
2	anode	1 2	#
		Transparent top view	sym008

<sup>[1]</sup> The marking bar indicates the cathode.

# 3. Ordering information

Table 2. Ordering information

Type number	Package	ackage				
	Name	Description	Version			
BB182LX	布括	leadless ultra small plastic package; 2 terminals; body $1.0 \times 0.6 \times 0.4$ mm	SOD882T			





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### VHF variable capacitance diode

# 4. Marking

Table 3. Marking codes

Type number	Marking code
BB182LX	L7

# 5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{R}$	reverse voltage		-	32	V
I <sub>F</sub>	forward current		-	20	mA
T <sub>stg</sub>	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

## 6. Characteristics

Table 5. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$I_R$	reverse current	see Figure 3				
		V <sub>R</sub> = 30 V	-	-	10	nΑ
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	-	-	200	nΑ
r <sub>s</sub>	diode series resistance	$f = 100 \text{ MHz}$ at $C_d = 30 \text{ pF}$ ; see Figure 2	-	1.0	-	Ω
$C_{d}$	diode capacitance	f = 1 MHz; see <u>Figure 1</u> and <u>Figure 4</u>				
		V <sub>R</sub> = 1 V	52	-	62	pF
		V <sub>R</sub> = 28 V	2.48	2.7	2.89	pF
$C_{d(1V)}/C_{d(2V)}$	diode capacitance ratio (1 V to 2 V)	f = 1 MHz	-	1.31	-	
C <sub>d(1V)</sub> /C <sub>d(28V)</sub>	diode capacitance ratio (1 V to 28 V)	f = 1 MHz	20.6	22	-	
C <sub>d(25V)</sub> /C <sub>d(28V)</sub>	diode capacitance ratio (25 V to 28 V)	f = 1 MHz	-	1.05	-	
$\Delta C_d/C_d$	diode capacitance matching	$V_R = 1 \text{ V to } 28 \text{ V; in sequence of } 5 \text{ diodes (gliding)}$	-	-	2	%

### VHF variable capacitance diode

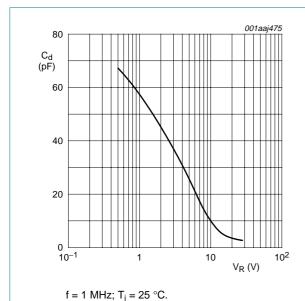


Fig 1. Diode capacitance as a function of reverse voltage; typical values

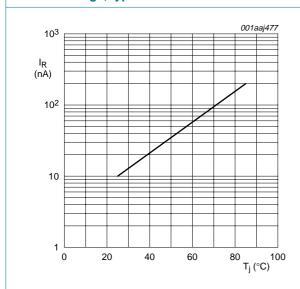
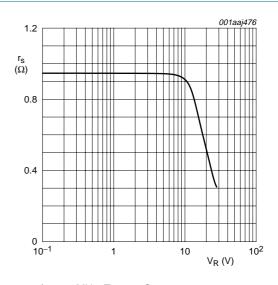
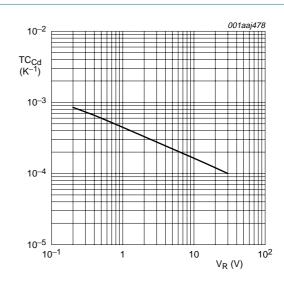


Fig 3. Reverse current as a function of junction temperature; maximum values



f = 100 MHz;  $T_{j}$  = 25  $^{\circ}C.$ 

Fig 2. Diode serial resistance as a function of reverse voltage; typical values



 $T_i = 0$  °C to 85 °C.

Fig 4. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values

# 7. Package outline

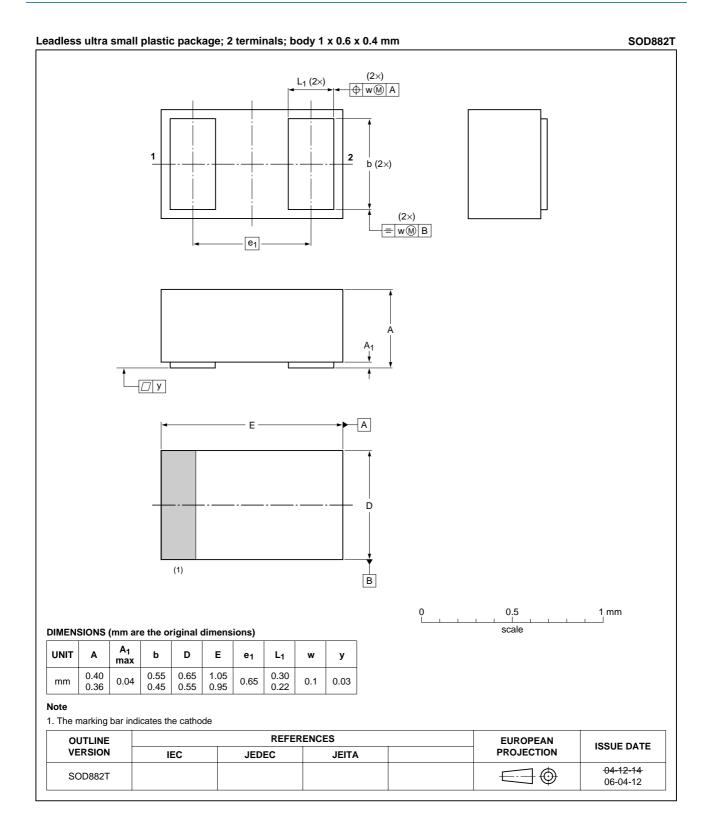


Fig 5. Package outline SOD882T

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## VHF variable capacitance diode

# 8. Abbreviations

### Table 6. Abbreviations

Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

# 9. Revision history

#### Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB182LX_1	20090129	Product data sheet	-	-

#### VHF variable capacitance diode

## 10. Legal information

#### 10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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NAP Semie on ductors

# **BB182LX**

### VHF variable capacitance diode

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